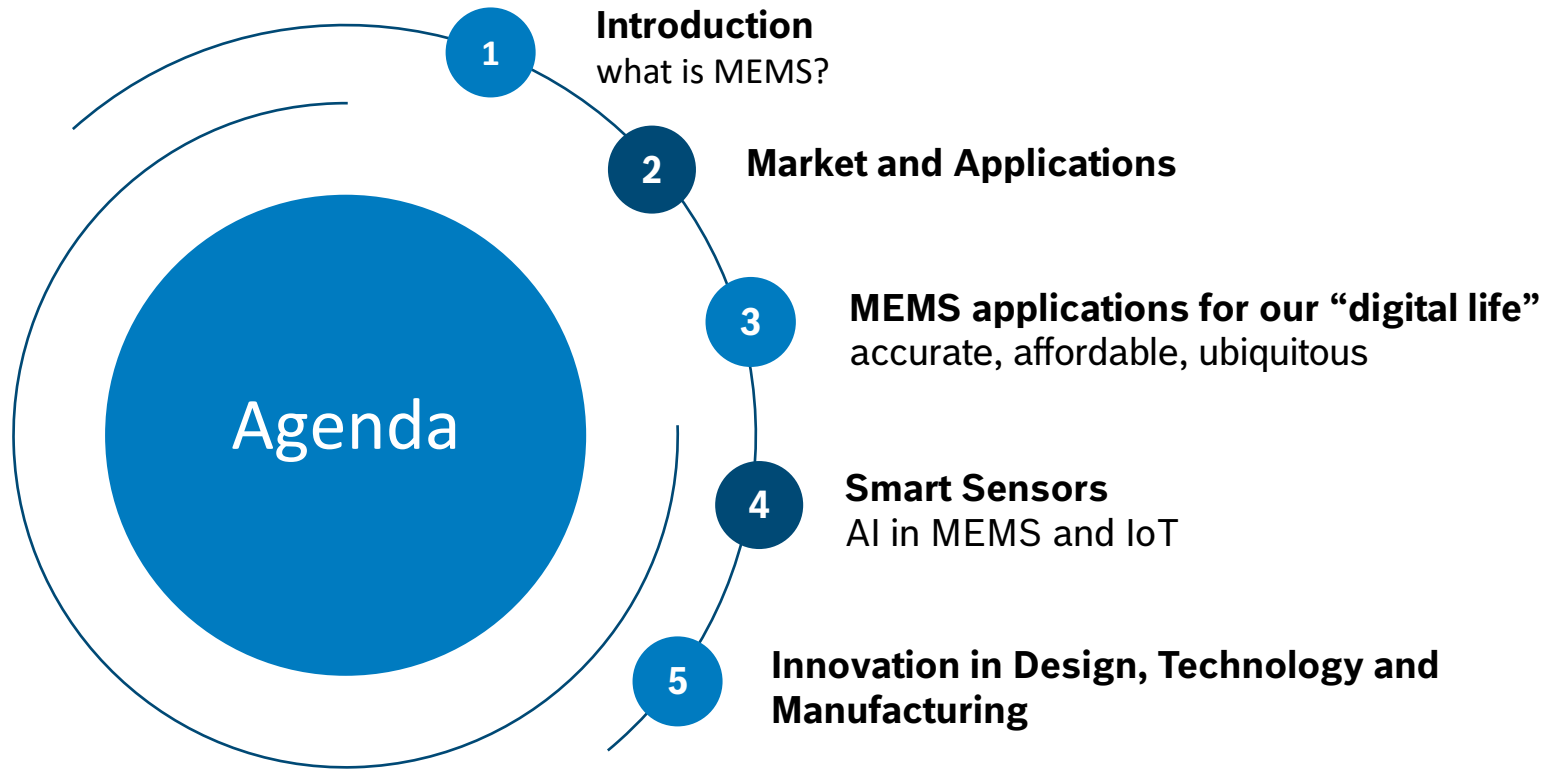


# Innovation in MEMS for the IoT and our digital lifestyle

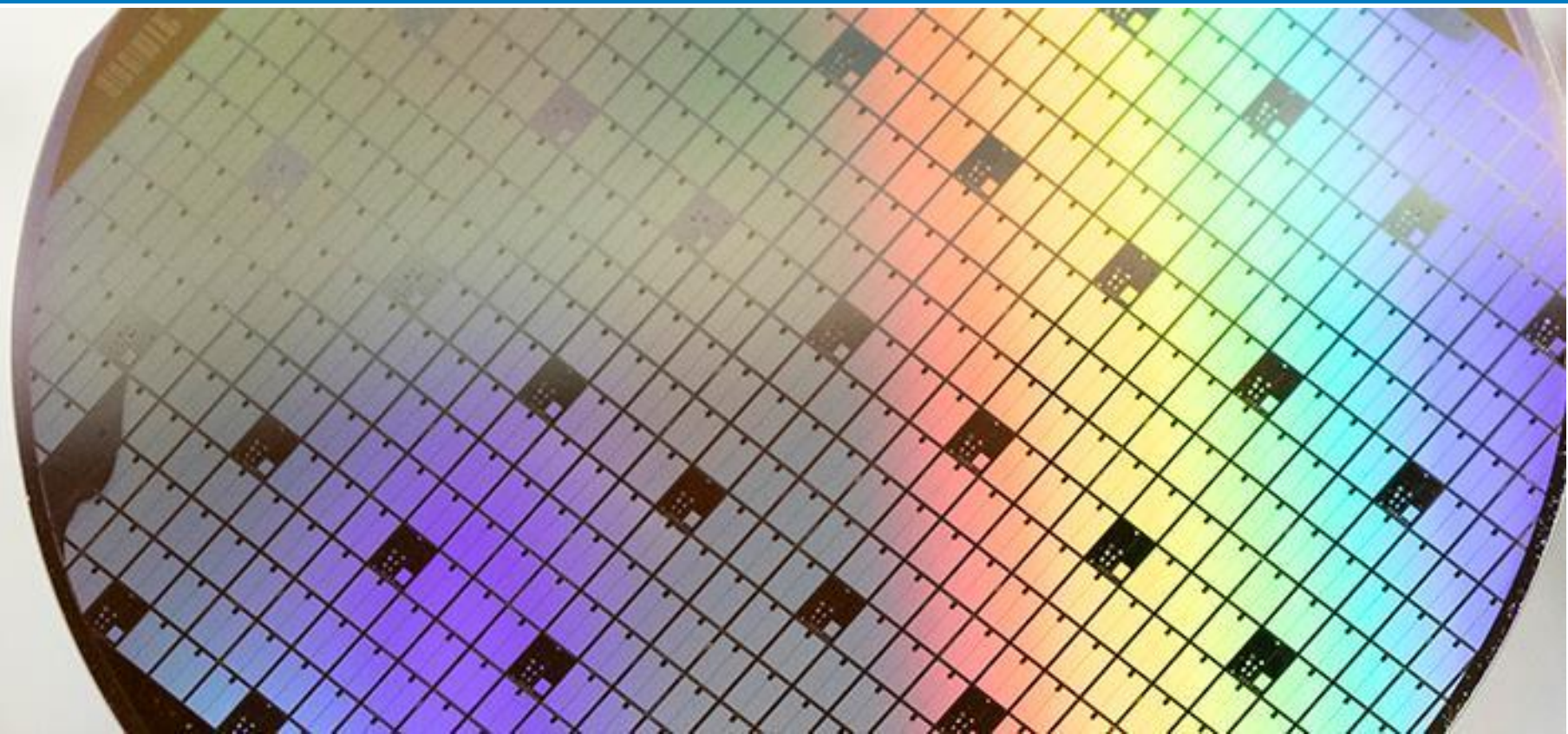
**Dr. Matthias Illing,  
Program coordinator cooperative R&D  
Robert Bosch GmbH**

# Overview



# 01

## Introduction



# Bosch semiconductors

## Frontend sites

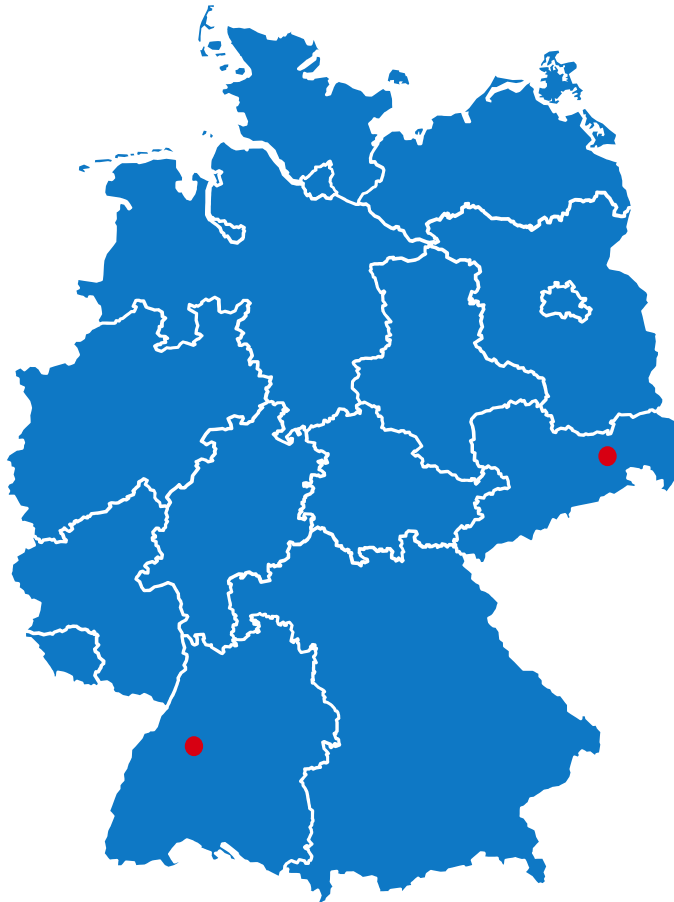
### REUTLINGEN (1970, 1995, 2010)

Wafer size 150mm, **200 mm**

Floor space 12 000 m<sup>2</sup>

Nodes 1  $\mu$ m ... 180 nm

Technologies: Mixed signal, Power MOS, SiC, **MEMS**



### DRESDEN (since 2020)

Wafer size **300 mm**

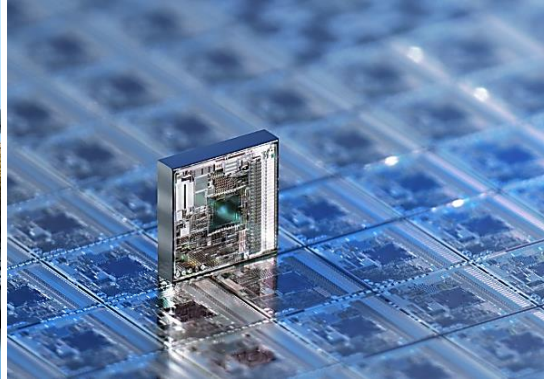
Floor space 10 000 m<sup>2</sup>

Node capability 180 ... 65 nm

Start technology: **Mixed signal, Power MOS**

# Bosch semiconductors

## A MEMS pioneer

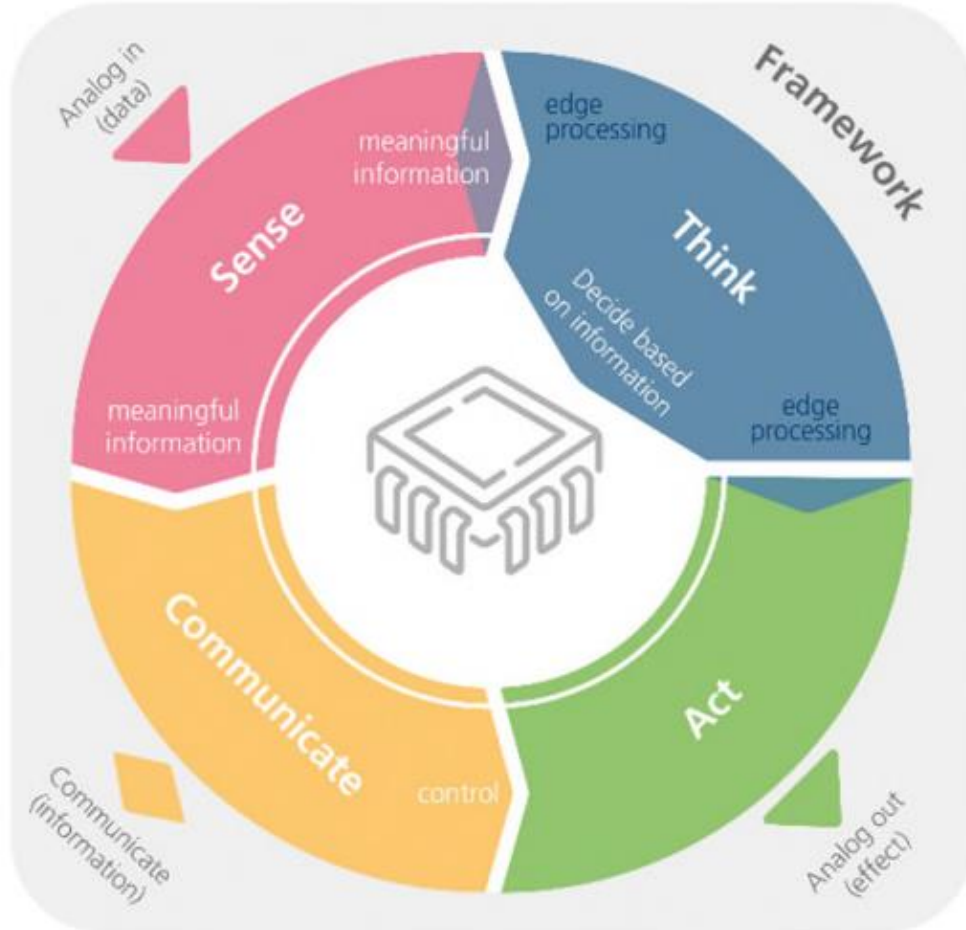


- Start of MEMS production in 1995
- More than 15 billion MEMS sensors produced
- More than 1000 MEMS patents
- 100% in-house – from MEMS design to MEMS manufacturing

**Bosch - Decades of expertise in MEMS development and MEMS mass production**

# Innovation in MEMS for IoT and digital life

## Semiconductors come in many ,colors' and functions ...



... and the digital life needs all of them

Today's focus: **Sense**.  
And a bit of **Think** and **Act...**

# Innovation in MEMS for IoT and digital life

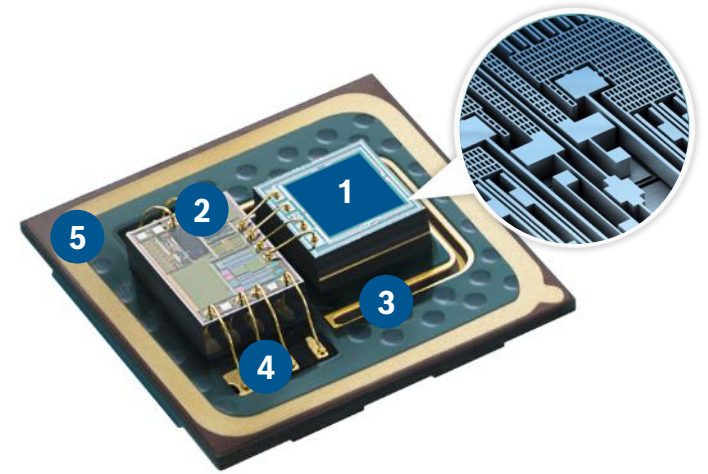
## What are MEMS and ASICs?

### Micro-Electro-Mechanical Systems

- MEMS is a chip-based technology where sensors are composed of miniaturized mechanical and electro-mechanical elements. Typical individual structures have a size of a few  $\mu\text{m}$ .

### Application-Specific Integrated Circuit

- ASICs are custom integrated circuits designed for individual MEMS sensors and consist of, for example, amplifiers, ADCs and communication interfaces.



- 1 MEMS
- 2 ASIC
- 3 Decoupling unit
- 4 Bonding wires
- 5 Printed Circuit Board (PCB)

# 02 Market and Application fields

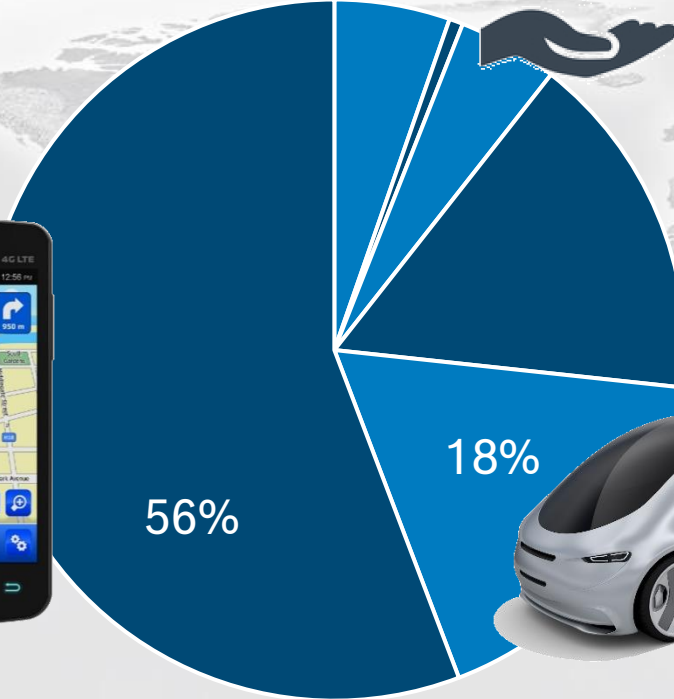




# Innovation in MEMS for IoT and digital life

## Global MEMS market 2022\*

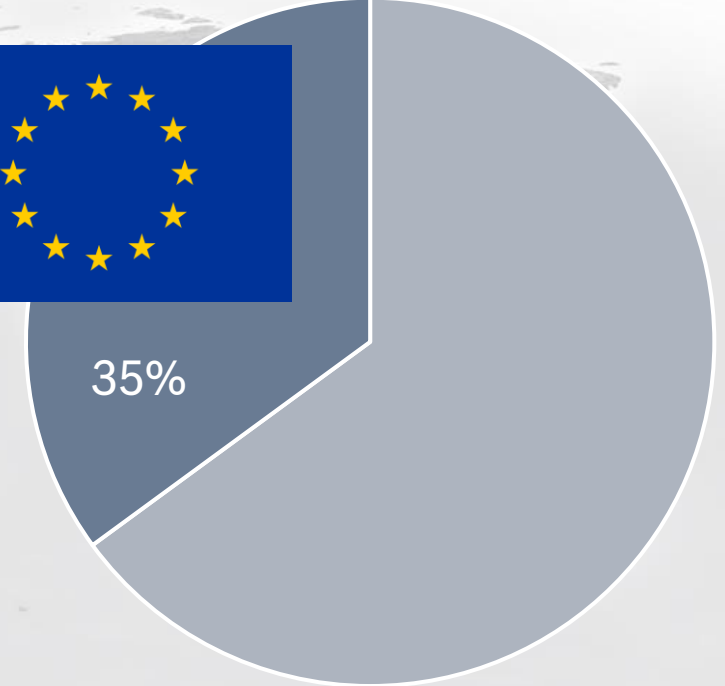
by application



by region of manufacturer



35%



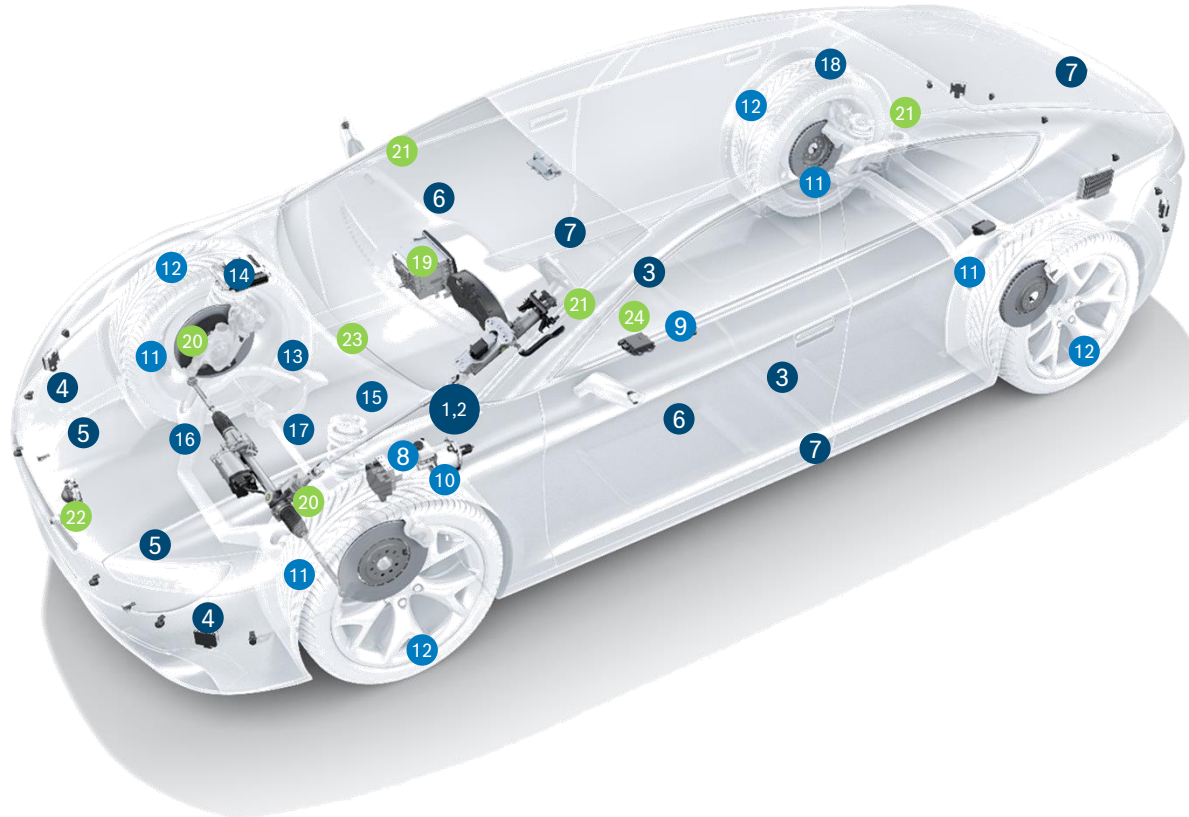
\*) Source: Yole Status of the MEMS Industry Report 2022

**EUR 14bn+, 30+ bn sensors yearly – The heart of multiple applications world-wide!**

# Innovation in MEMS for IoT and digital life

## Automotive Applications

More than 50 MEMS sensors per car



### Passive Safety

- 1 High G acceleration sensors for AB-ECU and eCall
- 2 Rollover sensor for Airbag ECU
- 3 Occupant weight sensors or pressure sensors
- 4 PTS – Pedestrian tube sensors
- 5 UFS - Upfront sensors
- 6 PPS - Peripheral pressure sensors
- 7 PAS - Peripheral acceleration sensors

### Active Safety

- 8 Inertial sensors für ESP, RSC, RoSe
- 9 MM – Sensor cluster for ESP (accel + gyro)
- 10 High pressure sensor for ESP
- 11 Low G acceleration sensors for active suspension
- 12 TPMS- Tire pressure monitoring system

### Power Train

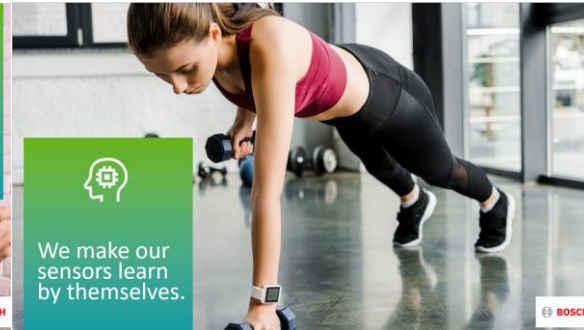
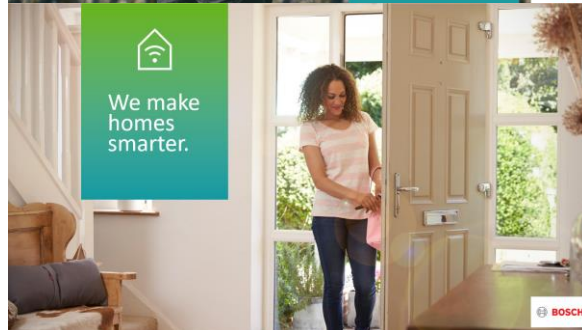
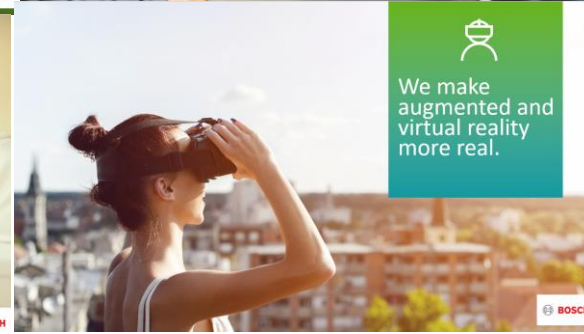
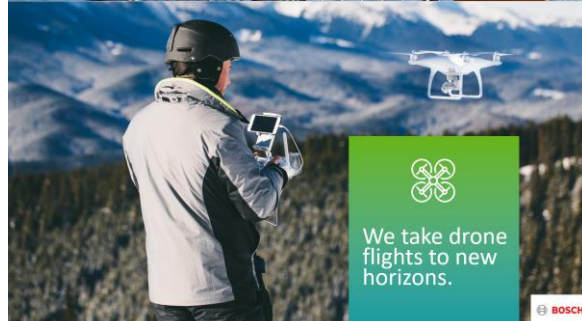
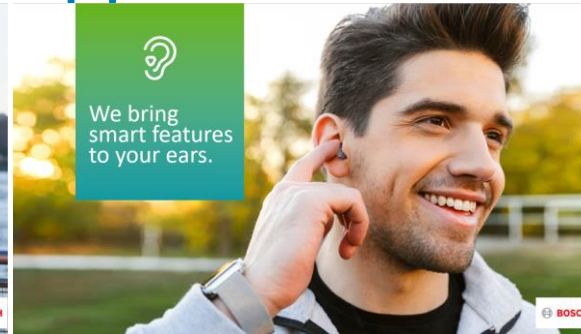
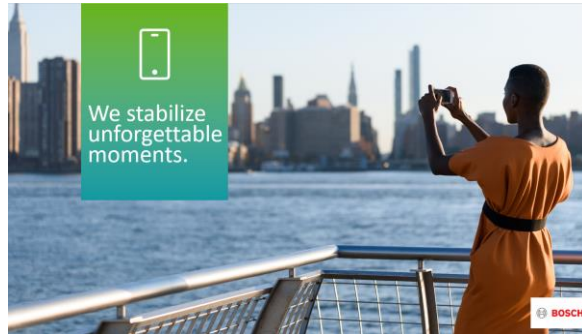
- 13 MAP – Manifold air pressure
- 14 BAP – Barometric air pressure
- 15 Medium Pressure for transmission
- 16 Mass flow sensor
- 17 High pressure sensor for fuel injection
- 18 Tank pressure sensor

### Comfort Functions

- 19 Inertial sensor for navigation
- 20 Motor damping / noise cancellation
- 21 Microphones
- 22 Night vision
- 23 Gas / air quality and humidity
- 24 Car alarm













# Innovation in MEMS for IoT and digital life

## Consumer Electronics Applications



# Innovation in MEMS for IoT and digital life

## MEMS products – Innovative and smart sensors for consumer

Motion sensors	Environmental sensors	Smart sensor systems	Optical microsystems
 <p><b>Absolute orientation sensor</b> (BMX)*</p>	 <p><b>Gas sensor</b> (BME)</p>	 <p><b>AI sensor systems</b> (BHI260AP)</p>	 <p><b>Smartglasses Light Drive (BML)</b></p>
 <p><b>Inertial measurement unit</b> (BMI)</p>	 <p><b>Humidity sensor</b> (BME)</p>	 <p><b>Programmable sensor systems</b> (BHI, BHA)</p>	
 <p><b>Accelerometer</b> (BMA)</p>  <p><b>Magnetometer</b> (BMM)</p>	 <p><b>Barometric pressure sensor</b> (BMP)</p>	 <p><b>Sensor nodes</b> (BNO)</p>	
 <p><b>Software &amp; tools, embedded algorithms and AI solutions</b></p>			

# Innovation in MEMS for IoT and digital life

## Market drivers

### Smaller

- ▶ Size causes cost
- ▶ Size limits design

### Ultra low power

- ▶ Always-on applications
- ▶ Power management

### Performance

- ▶ Higher accuracy
- ▶ Lower noise

### Smarter

- ▶ Integrated data processing
- ▶ Embedded software / algorithms
- ▶ Functionality for use cases

### New measurants

- ▶ Environmental data
- ▶ Imaging

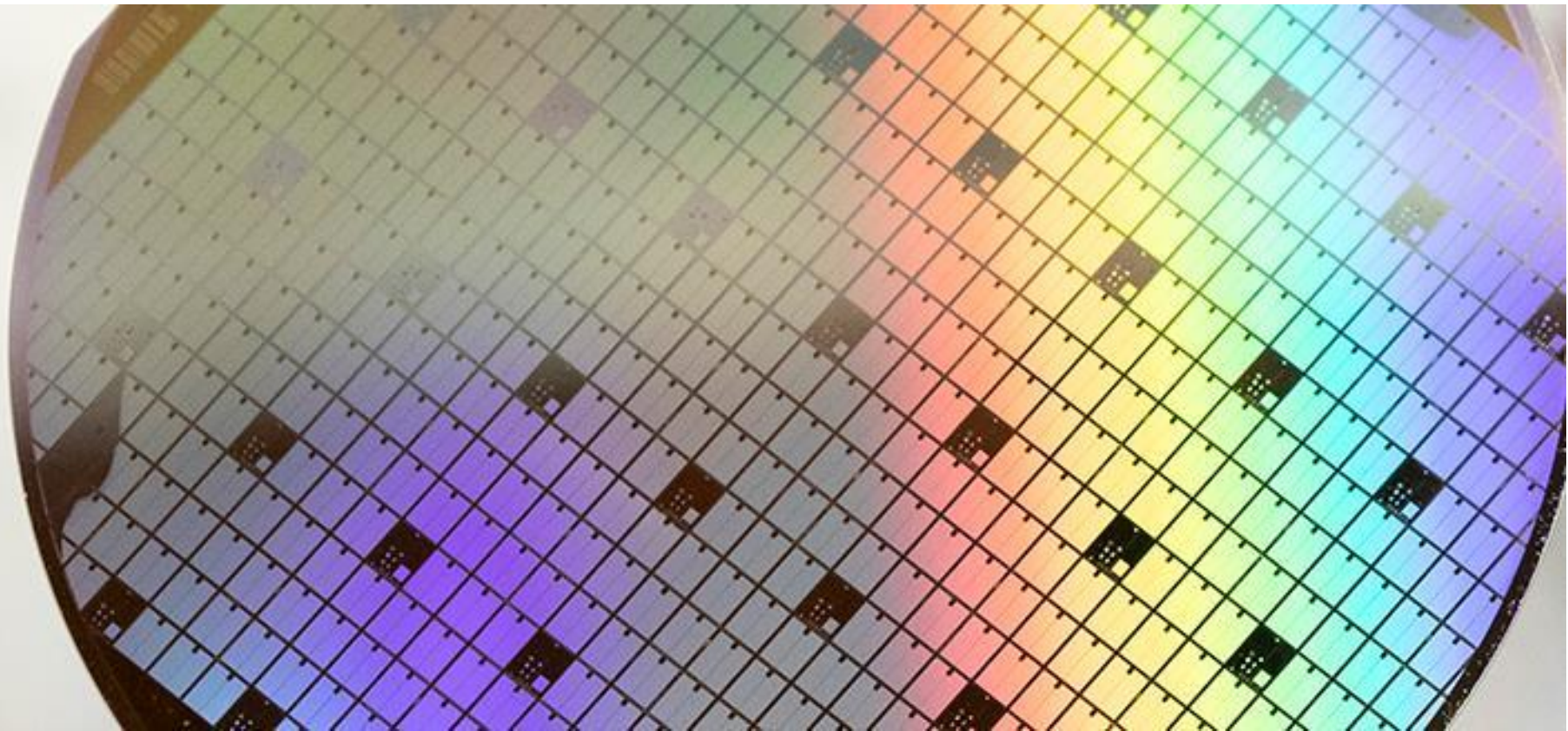
### Connectivity

- ▶ SPI, I<sup>2</sup>C, MIPI I3C, GPIO
- ▶ BTLE, WiFi, LoRa for IoT, I4.0, ...



# 03

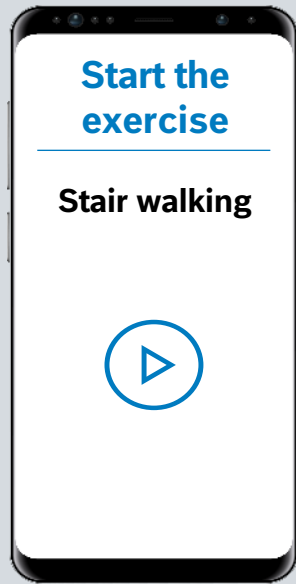
## Applications for MEMS accurate, tiny, ubiquitous



# Innovation in MEMS for IoT and digital life

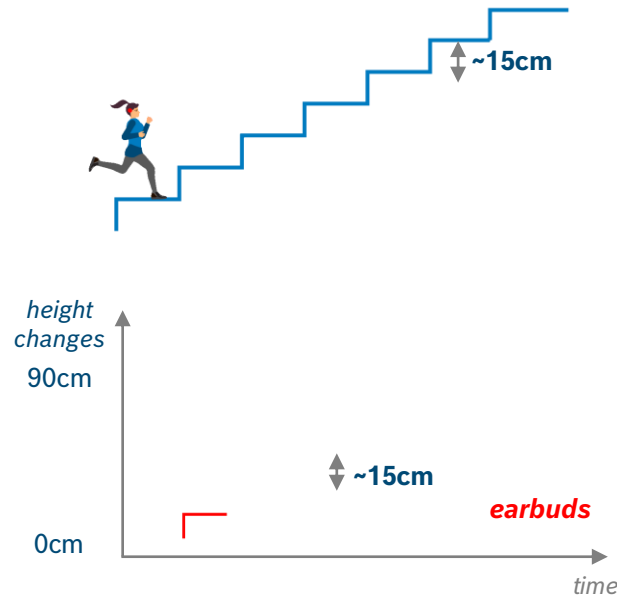
## Example: Measuring smallest height changes during stair walking

Switch on the app connected to your earbuds:

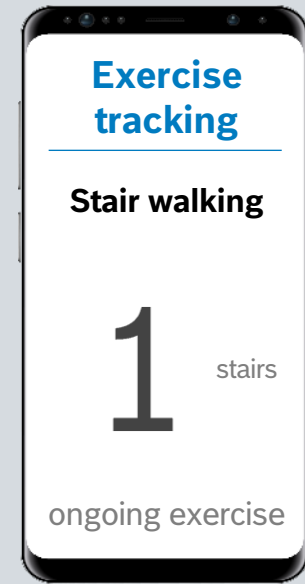


Start with the stair walking exercise:

earbuds •



Look at your fitness tracking app.  
The sensor accurately measures the height changes and recognizes the exercise:



Measuring smallest height changes during stair walking with the barometric pressure sensor BMP581

# Innovation in MEMS for IoT and digital life


## Example step height: What does accuracy of 17.5cm mean?

### Walking the stairs or measurement to the extreme



- piezoresistive pressure sensor
- capacitive pressure sensor

### Equivalent of

	/ 11	~17.5 cm step height air column <b>13km vs. 13km + 17.5cm</b>
		2,1 Pa = ~0,002% pressure difference <b>101300 Pa vs. 101302 Pa</b>
	/ 1.000	<b>~7.6 µg</b> weight change of air
	/ 1.000.000	<b>~12.6 aF</b> capacitance change

**Resolving 17.5cm with a pressure sensor means measuring the charge difference of 60 electrons!**

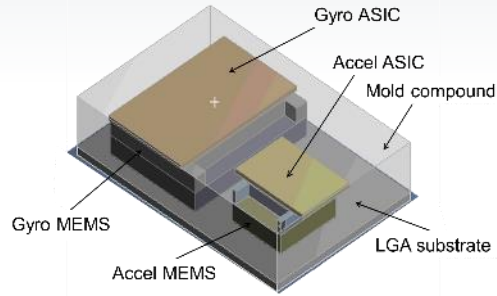
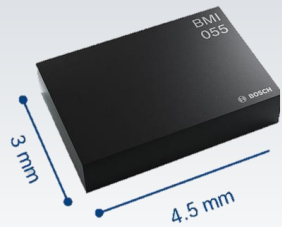


# Innovation in MEMS for IoT and digital life

## IMUs – New design approaches for miniaturization

### Example: Overview integration concepts Bosch Sensortec IMUs for CE

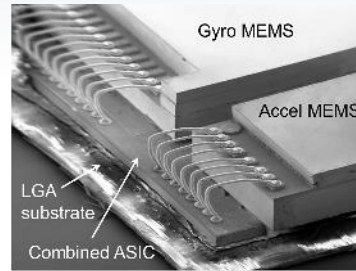
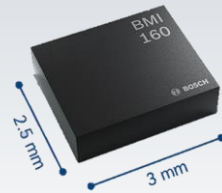
#### BMI055 (2012)



**2 ASICs + 2 MEMS**  
**I = 5 mA**

**-44%**  
➔

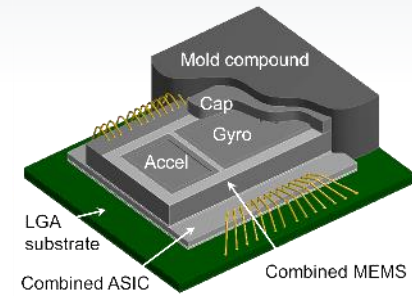
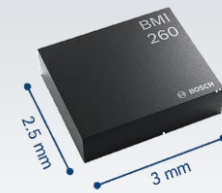
#### BMI160 (2014)



**1 ASIC + 2 MEMS**  
**I = 0.95 mA**

same size  
➔  
pin-to-pin compatibility

#### BMI260 (2018)

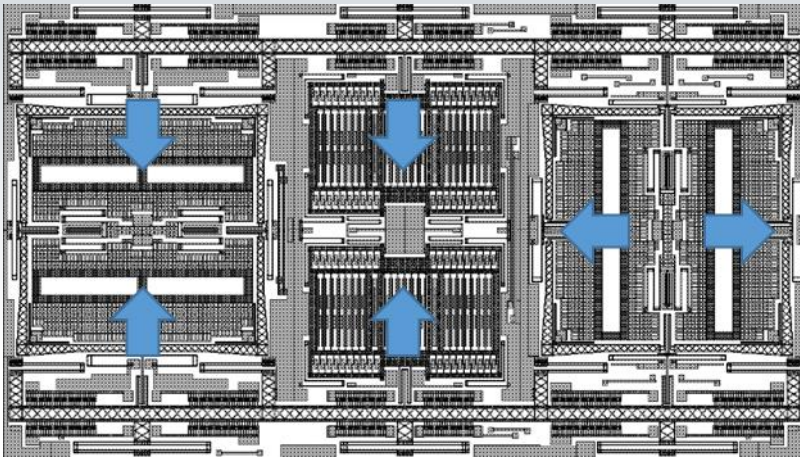


**1 ASIC + 1 MEMS**  
**I = 0.68 mA**

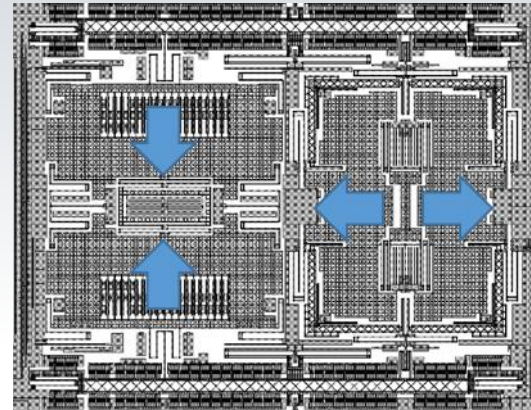
# Innovation in MEMS for IoT and digital life

## IMUs – Evolution of gyroscope sizes

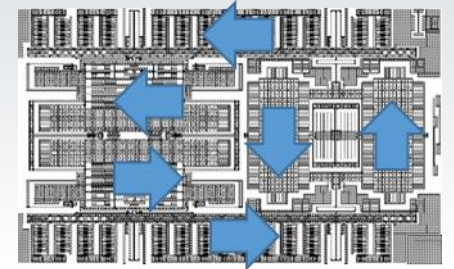
**BMI055 (2012)**



**BMI160 (2014)**



**BMI260 (2018)**



1 / 3.3

**Shrink by factor 3.3 achieved within two gyro generations**

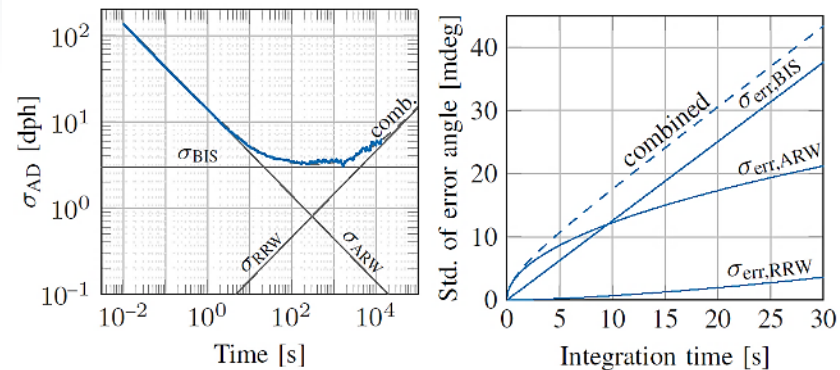
# Innovation in MEMS for IoT and digital life

## Example Localization – Why is inertial sensor bias important?

### ▪ Role of Bias instability BIS

- Bias instability is a measure of slow signal fluctuations without external stimulus
- During navigation fluctuations are integrated and lead to orientation errors
- BIS is quantified by **Allan variance**

Typ. Allan variance and std. angle error of integrated rate signal



### ▪ Normal vs. high performance IMU



**Bias instability is critical for localization applications and a strong market driver for performance!**

# NASA MISSION

Bosch MEMS sensors  
stabilize

**NASA'S INGENUITY  
MARS HELICOPTER**



# 04

Smart sensors

Artificial intelligence in MEMS



PATTERN  
RECOGNITION



AUTOMATION



NEURAL  
NETWORKS



ARTIFICIAL  
INTELLIGENCE



DATA MINING



ALGORITHM



PROBLEM  
SOLVING

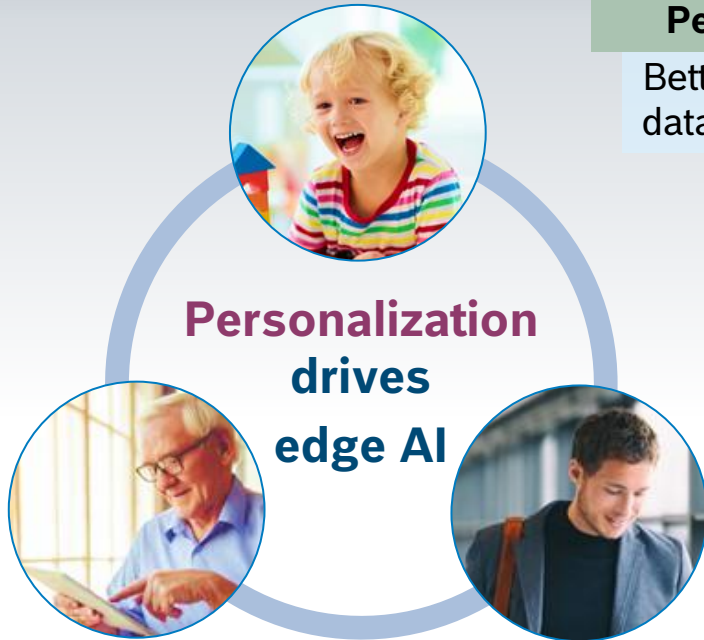
**MACHINE  
LEARNING**  
... ..

# Innovation in MEMS for IoT and digital life

## Examples: Self-learning AI sensor



### Edge AI market drivers and user benefits



#### Personalization

Better user adaptation, as only data of the user are collected

#### Privacy of user data

Low latency due to avoidance of data transfer

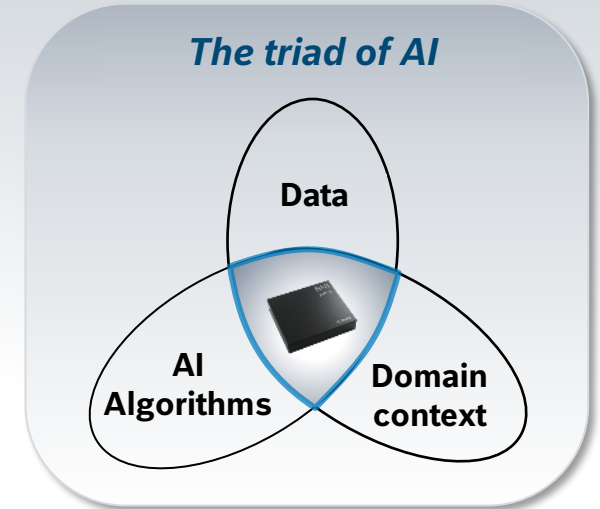
#### Real time feedback

Edge data processing without cloud involvement

#### Improved battery life

Demand-optimized data transmission and connectivity

### Critical success factors



Source: Santhanam P et. al. 'Engineering Reliable Deep Learning Systems', AAAI Fall Symp. Series on AI in Government & Public Sector, Nov. 7-9, 2019, p. 2

**AI creates value for the user, if one combine data, application knowledge, and algorithms intelligently!**

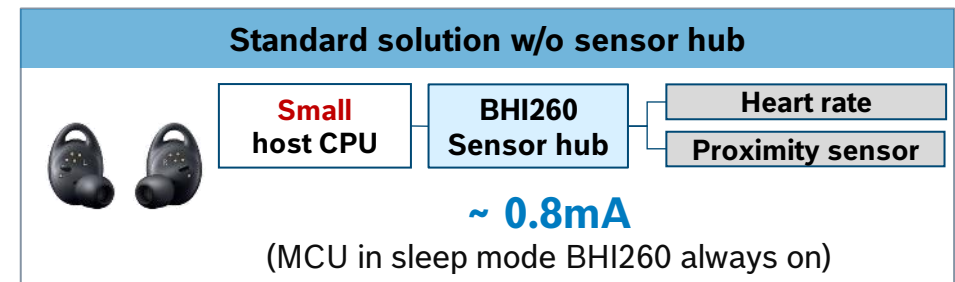
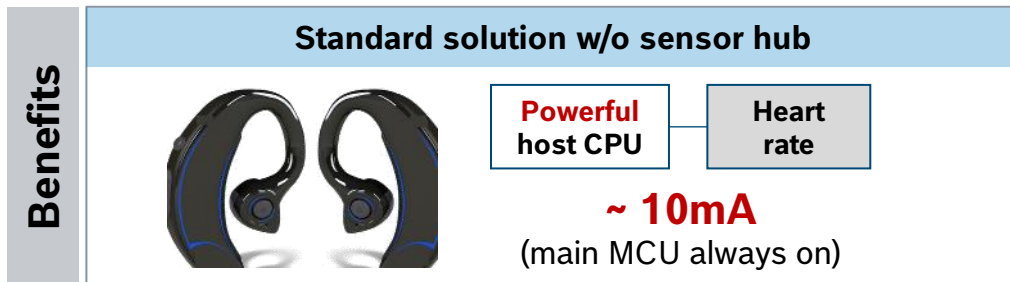
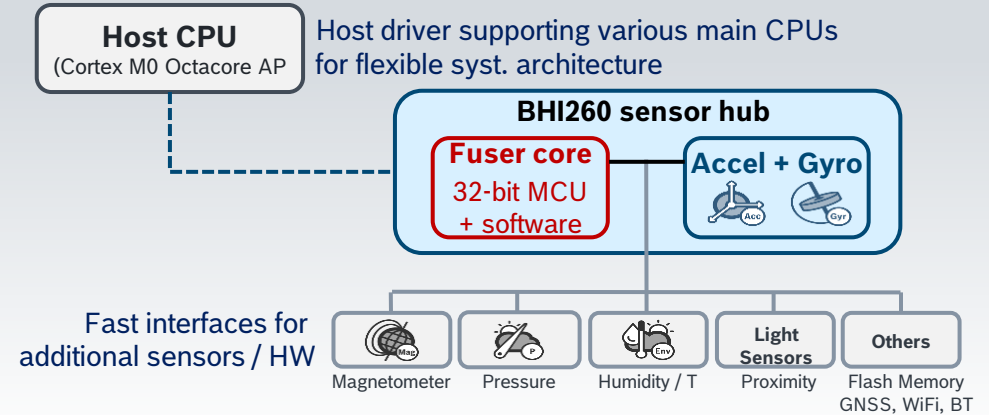
# Innovation in MEMS for IoT and digital life

## Examples: Integration, data fusion and sensor hub



- Complex use-cases with different sensors need smart sensor data fusion
- Solution: Smart sensor hub with integrated  $\mu$ C**
- Example:**
  - 6-axis motion sensor (gyro + accel)
  - 32-bit Fuser2 Core (ARC EM4 CPU)
  - Memory for software and data batching
  - Bosch Sensor Fusion BSX4 with 800Hz

### Sensor hub concept



**Enables smart sensing far beyond commodity at ultra-low power consumption**

# Innovation in MEMS for IoT and digital life

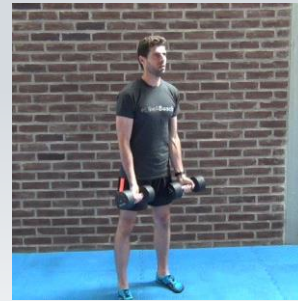
## Glimpse of automatically tracked activities via sensor with AI



Tricep extension



Bicep curl



Palm face



Bench press



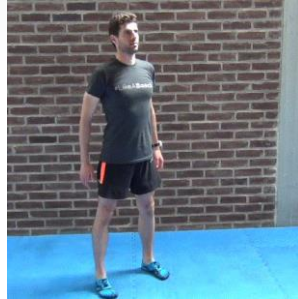
Chest fly



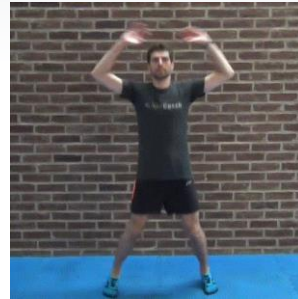
Pull over



Side lateral raise



Squats



Jumping jacks



Russian twist



Kettle bell swing

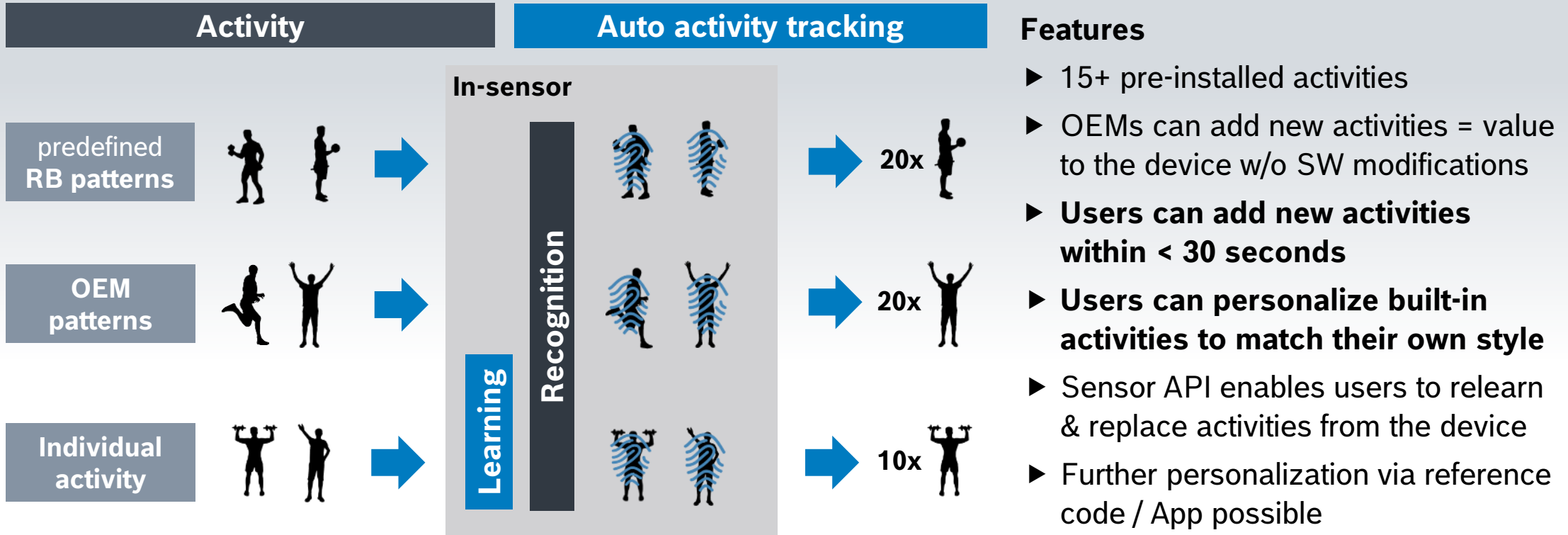


Row machine



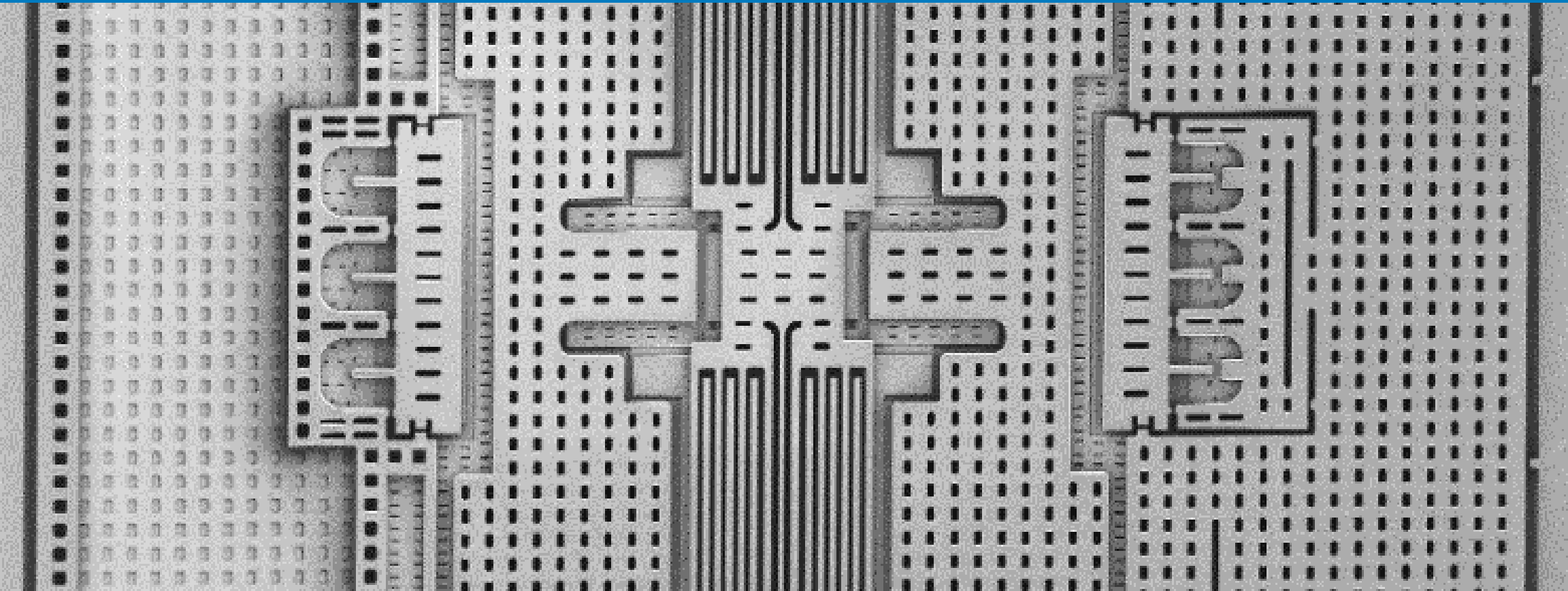
# Innovation in MEMS for IoT and digital life

## Example: Fitness tracking – Learn new activities from user



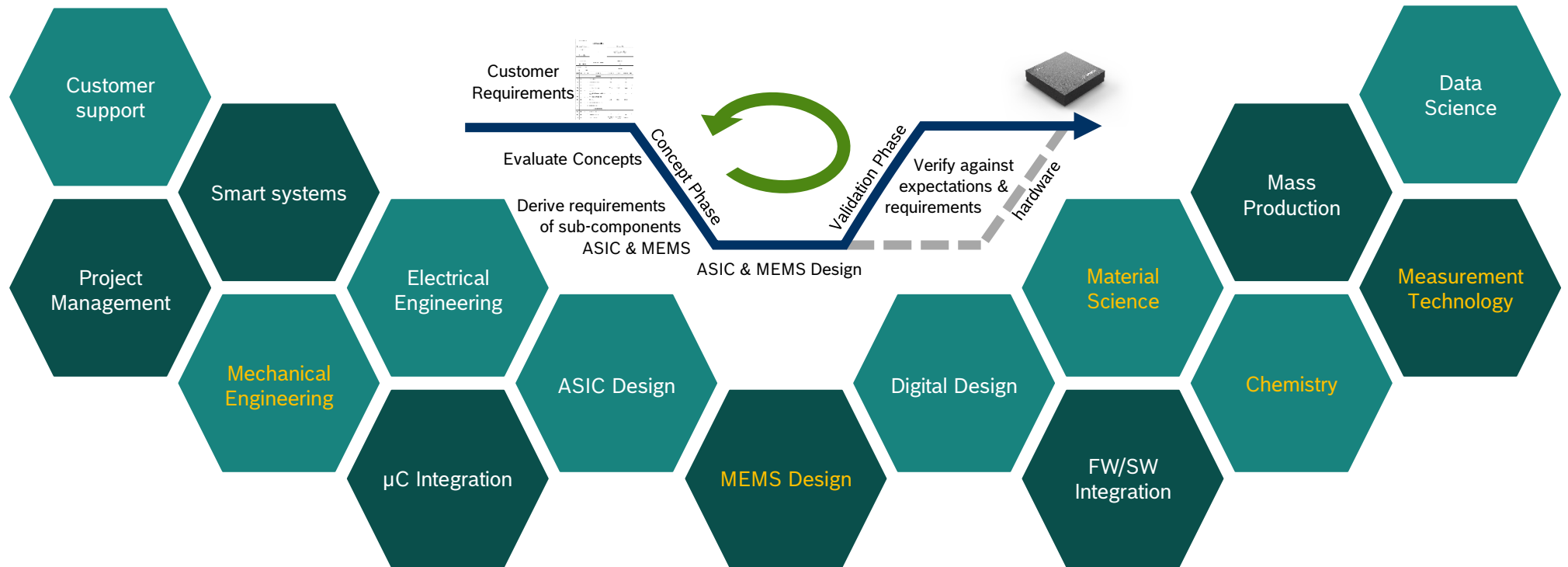
Self-learning sensors with AI open completely new personalization functions for the user

# 05 Design, Technology and Manufacturing



# Innovation in MEMS for IoT and digital life

## Broad spectrum of competences in interdisciplinary teams

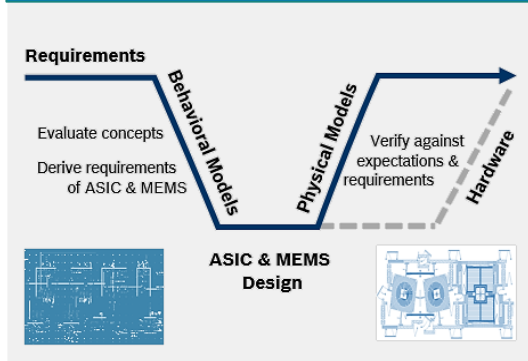


**A huge variety of different domains are needed in the MEMS development process**

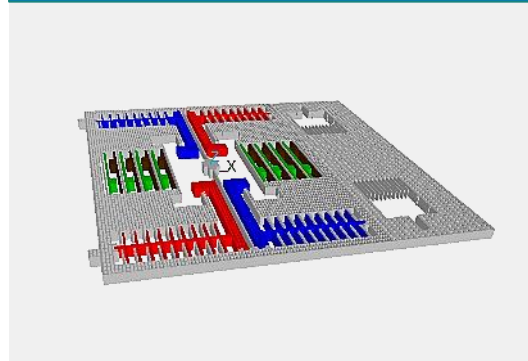
# Innovation in MEMS for IoT and digital life

## Modelling, design, simulation and software development

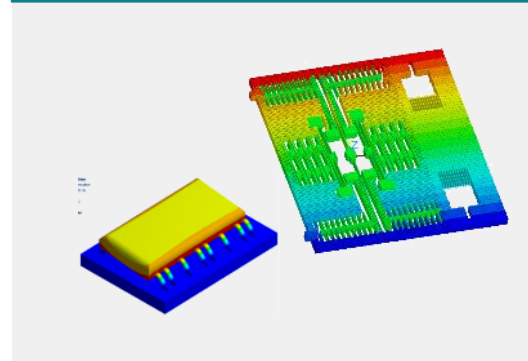
### Model based system engineering



### MEMS design



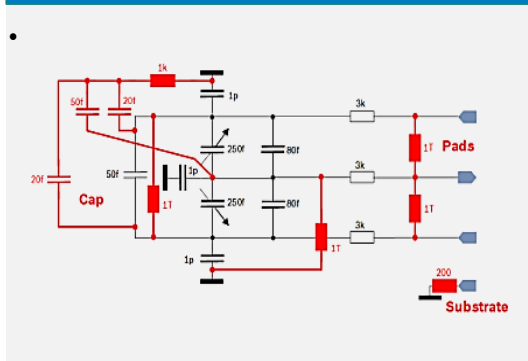
### MEMS and package simulation



### MEMS layout



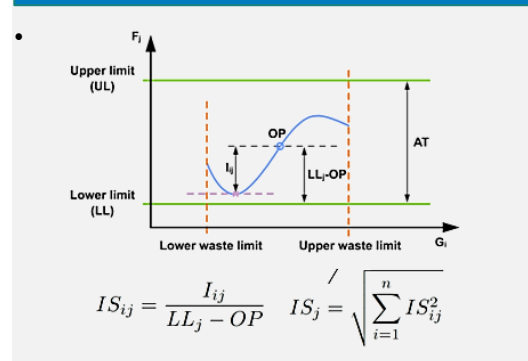
### Verification MEMS-ASIC-IF



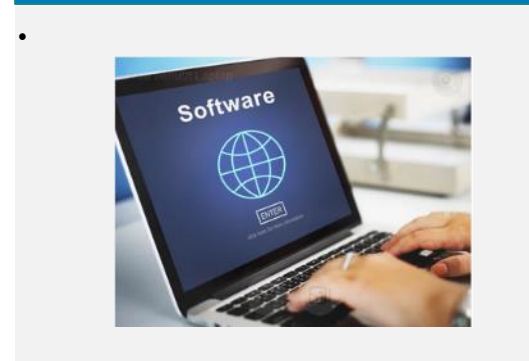
### Simulation tools / methods



### Sensitivity analysis / IFS



### Software / Algorithms / ML

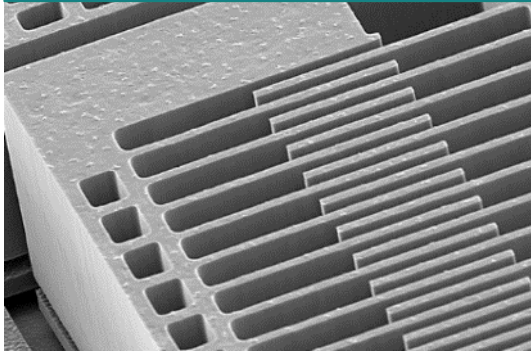


## Complex multidomain simulation/design with specialized tools

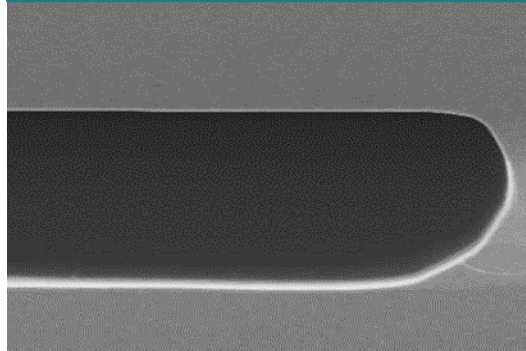
# Innovation in MEMS for IoT and digital life

## MEMS process technology

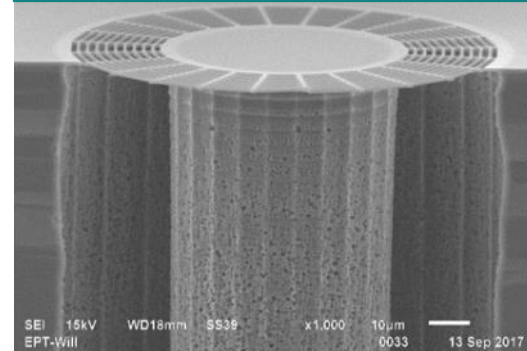
Surface Micromechanics



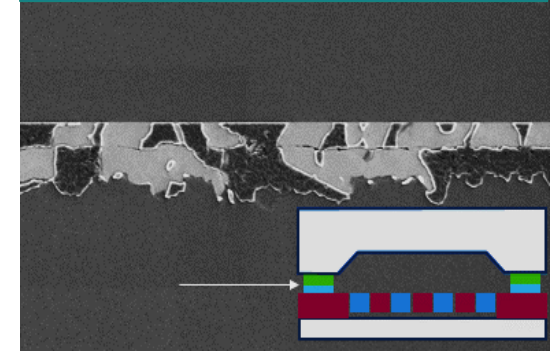
APSM – Porous Silicon



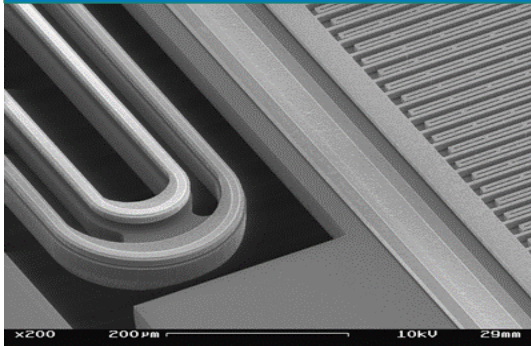
Trough Silicon Vias



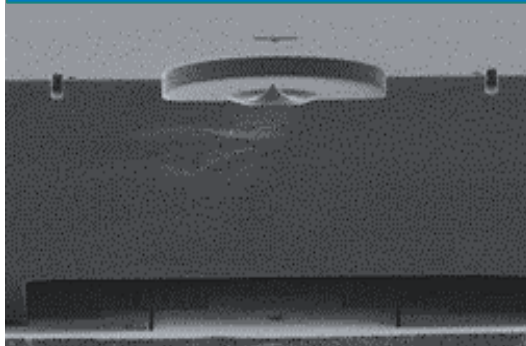
Eutectic wafer bonding



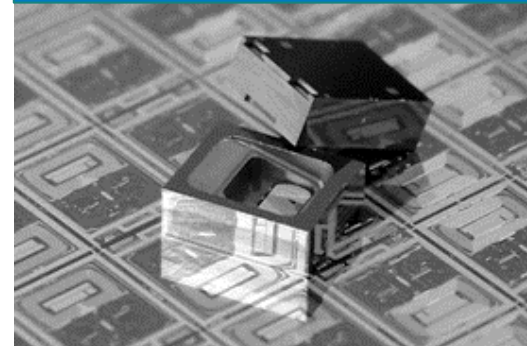
Bulk Micromechanics



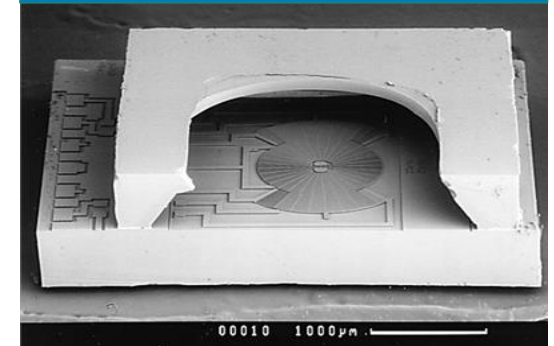
Laser Reseal



MEMS actors



Anodic and glass frit bonding

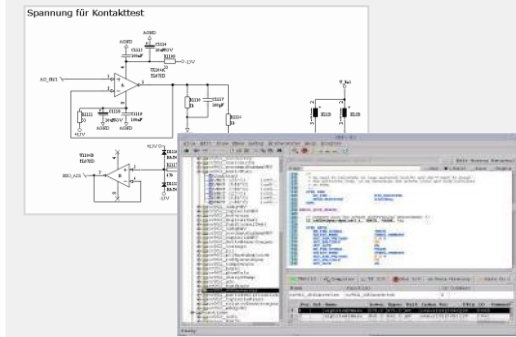


Silicon process innovation generates new functionality for the user

# Innovation in MEMS for IoT and digital life

## Testing, characterization and qualification

### Testing Hard- and Software



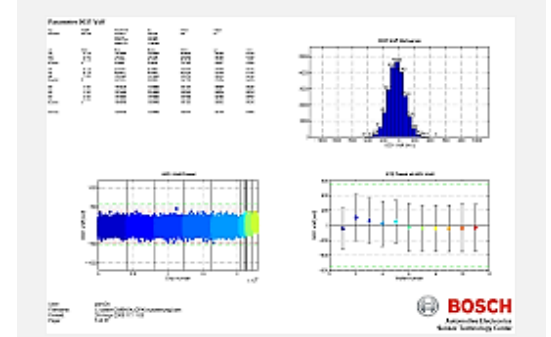
### Wafer Level Testing



### Multi-axis/ multi stimuli final test



### In depth data analysis



### Series Testing



### Lifetime Testing



### Vibrational Testing (Shaker)



### Physical and chemical analysis



**MEMS require very specific test and manufacturing equipment**

# 06 Summary



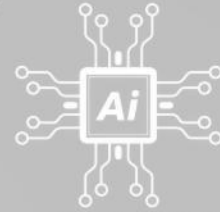
PATTERN  
RECOGNITION



AUTOMATION



NEURAL  
NETWORKS



ARTIFICIAL  
INTELLIGENCE



DATA MINING



ALGORITHM



PROBLEM  
SOLVING

**MACHINE  
LEARNING**  
... ..

# Innovation in MEMS for IoT and digital life

## Summary and conclusion

- **MEMS sensors make a difference** in our daily life ... and even on Mars.
- Progressing **strong innovation** scales size down and increases integration, accuracy and functionality
- The development of MEMS is a unique **cross domain challenge** requiring the best available engineering skills.
- **Europe has the ecosystem, the application and the experience** to continue a success-story in innovation and commercial success.



[1] [Bosch presents: Sensor tech #LikeABosch - YouTube](#)







THANK YOU



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